Dual 4-bit synchronous binary counter Rev. 3 — 4 December 2014

Product data sheet

1. **General description**

The 74HC4520; 74HCT4520 are dual 4-bit internally synchronous binary counters with two clock inputs (nCP0 and nCP1). They have buffered outputs from all 4 bit positions (nQ0 to nQ3) and an asynchronous master reset input (nMR). The counter advances on the LOW-to-HIGH transition of nCP0 when nCP1 is HIGH. It also advances on the HIGH-to-LOW transition of nCP1 when nCP0 is LOW. Either nCP0 or nCP1 may be used as the clock input to the counter. The other clock input may be used as a clock enable input. A HIGH on nMR, resets the counter (nQ0 to nQ3 = LOW) independent of nCP0 and nCP1. Inputs include clamp diodes. It enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. **Features and benefits**

- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC4520: CMOS level
 - For 74HCT4520: TTL level
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Applications

- Multistage synchronous counting
- Multistage asynchronous counting
- Frequency dividers

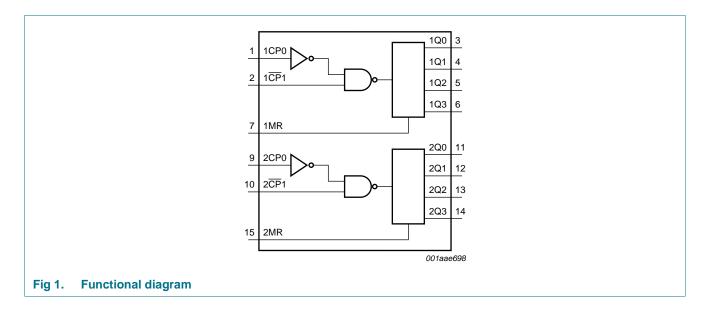


4. Ordering information

Table 1. Ordering information

Type number	Package	Package									
	Temperature range	Name	Description	Version							
74HC4520N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4							
74HCT4520N											
74HC4520D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1							
74HCT4520D			body width 3.9 mm								
74HC4520DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1							
74HCT4520DB			body width 5.3 mm								
74HC4520PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1							

5. Functional diagram



NXP Semiconductors

74HC4520; 74HCT4520

Dual 4-bit synchronous binary counter

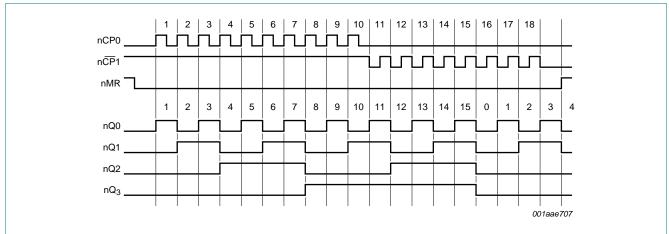
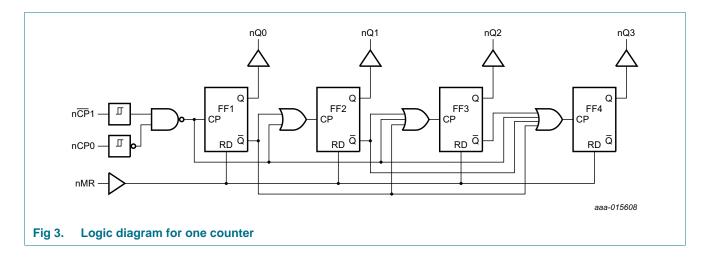


Fig 2. Timing diagram

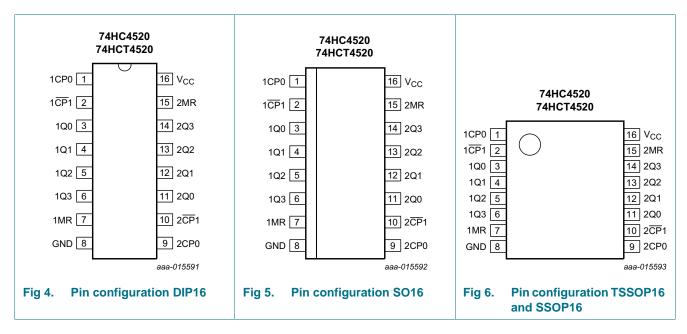


74HC_HCT4520

Dual 4-bit synchronous binary counter

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP0, 2CP0	1, 9	clock input (LOW-to-HIGH edge-triggered)
1 <u>CP</u> 1, 2 <u>CP</u> 1	2, 10	clock input (HIGH-to-LOW edge-triggered)
1Q0 to 1Q3	3, 4, 5, 6	output
1MR, 2MR	7, 15	asynchronous master reset input (active HIGH)
GND	8	ground (0 V)
2Q0 to 2Q3	11, 12, 13, 14	output
V _{CC}	16	supply voltage

Functional description 7.

Table 3. Function table ^[1]			
nCP0	nCP1	nMR	Mode
\uparrow	Н	L	counter advances
L	\downarrow	L	counter advances
\downarrow	Х	L	no change
Х	1	L	no change
\uparrow	L	L	no change
Н	\downarrow	L	no change
Х	Х	Н	nQ0 to nQ3 = LOW

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; \uparrow = positive-going transition; \downarrow = negative-going transition.

Limiting values 8.

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V		-	±20	mA
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V		-	±20	mA
lo	output current	$V_{O} = -0.5$ V to V_{CC} + 0.5 V		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	DIP16 package	[1]	-	750	mW
		SO16 package	[1]	-	500	mW
		(T)SSOP16 package	[1]	-	500	mW

[1] For DIP16 packages: above 70 °C the value of P_{tot} derates linearly at 12 mW/K. For SO16 packages: above 70 $^\circ\text{C}$ the value of P_tot derates linearly at 8 mW/K. For (T)SSOP16 packages: above 60 $^\circ\text{C}$ the value of P_{tot} derates linearly at 5.5 mW/K.

Dual 4-bit synchronous binary counter

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	7	74HC4520			74HCT4520		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C te	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
74HC45	20	I	1	•				1	1	-
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0; V_{CC} = 4.5 V$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2; V_{CC} = 6.0 V$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current		-	-	8.0	-	80.0	-	160.0	μA

74HC_HCT4520

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Product data sheet

Dual 4-bit synchronous binary counter

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	–40 °C to	o +125 ℃	Unit	
			Min	Тур	Max	Min	Max	Min	Max		
CI	input capacitance		-	3.5	-	-	-	-	-	pF	
74HCT4	520		1	1		1		1	<u> </u>	-	
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V	
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V	
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$									
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V	
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V	
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$									
	output voltage	l _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V	
		l _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V	
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA	
I _{CC}	supply current		-	-	8.0	-	80.0	-	160.0	μA	
ΔI_{CC}	additional	per input pin; $V_I = V_{CC} - 2.1 V$;	other in	puts at	V _{CC} or	GND; V _C	_C = 4.5 V	to 5.5 V; I	_O = 0 A		
	supply current	pin nCP0, nCP1	-	80	288	-	360	-	392	μA	
		pin nMR	-	150	540	-	675	-	735	μA	
CI	input capacitance		-	3.5	-	-	-	-	-	pF	

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit, see <u>Figure 8</u>.

•						•			<u> </u>	
Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	• +125 °C	Unit
			Min	Тур	Мах	Min	Max	Min	Max	
74HC452	20		I	1				1		
t _{pd}	propagation	nCP0 to nQn; see Figure 7	[1]							
	delay	V _{CC} = 2.0 V	-	77	240	-	300	-	360	ns
		V _{CC} = 4.5 V	-	28	48	-	60	-	72	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	41	-	51	-	61	ns
		nCP1 to nQn; see Figure 7	[1]						-	
		V _{CC} = 2.0 V	-	77	240	-	300	-	360	ns
		V _{CC} = 4.5 V	-	28	48	-	60	-	72	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	24	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	22	41	-	51	-	61	ns

74HC_HCT4520

Dual 4-bit synchronous binary counter

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{PHL}	HIGH to LOW	nMR to nQn; see Figure 7								
	propagation	V _{CC} = 2.0 V	-	44	150	-	190	-	225	ns
	delay	V _{CC} = 4.5 V	-	16	30	-	38	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	13	-	-	-	-	-	ns
		$V_{\rm CC} = 6.0 \rm V$	-	13	26	-	33	-	38	ns
t _t	transition	nQn; see Figure 7 [2]								
·	time	$V_{CC} = 2.0 V$	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$	-	6	13	-	16	-	19	ns
t _W	pulse width	nCP0, nCP1 HIGH or LOW; see Fi	gure 7	7						
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		nMR HIGH; see Figure 7								
		$V_{\rm CC} = 2.0 \rm V$	120	39	-	150	-	180	-	ns
		$V_{CC} = 4.5 V$	24	14	-	30	-	36	-	ns
		$V_{CC} = 6.0 V$	20	11	-	26	-	31	-	ns
t _{rec}	recovery time	nMR to nCP0, nCP1; see Figure 7								
	-	V _{CC} = 2.0 V	0	-28	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-10	-	0	-	0	-	ns
		$V_{CC} = 6.0 V$	0	-8	-	0	-	0	-	ns
t _{su}	set-up time	nCP0 to nCP1; nCP1 to nCP0; see	Figu	re 7						
	-	V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	5	-	20	-	24	-	ns
		$V_{\rm CC} = 6.0 \text{ V}$	14	4	-	17	-	20	-	ns
f _{max}	maximum	nCP0, nCP1; see Figure 7								-
	frequency	$V_{\rm CC} = 2.0 \text{ V}$	6	19	-	4.8	-	4	-	MHz
		$V_{CC} = 4.5 V$	30	58	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	68	-	-	-	-	-	MHz
		$V_{\rm CC} = 6.0 \rm V$	35	69	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	$V_{I} = GND$ to V_{CC} ; $V_{CC} = 5$ V; [3] $f_{i} = 1$ MHz	-	29	-	-	-	-	-	pF
74HCT4	-									
t _{pd}	propagation	nCP0 to nQn; see Figure 7 [1]								
•ha	delay	$V_{CC} = 4.5 V$	_	28	53	-	66	_	80	ns
		$V_{CC} = 4.3 V$ $V_{CC} = 5.0 V; C_L = 15 pF$	-	20	-	-	-	-	-	ns
		$n\overline{CP1}$ to nQn; see Figure 7 [1]		2-7				<u> </u>		10
		$V_{CC} = 4.5 V$	_	25	53	_	66	-	80	ns
		$V_{CC} = 4.5 V$ $V_{CC} = 5.0 V; C_{L} = 15 pF$		23	-	_	00	_	00	ns

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_1 = 50 \text{ pF}$ unless otherwise specified; for test circuit, see Figure 8.

Product data sheet

Dual 4-bit synchronous binary counter

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Мах	Min	Max	Min	Max	-
t _{PHL}	HIGH to LOW	nMR to nQn; see Figure 7								
	propagation	V _{CC} = 4.5 V	-	16	35	-	44	-	53	ns
delay		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	13	-	-	-	-	-	ns
t _t	transition	nQn; see Figure 7 [2]								
	time	V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t _W	pulse width	nCP0, nCP1 HIGH or LOW; see Fi	gure 7	7						
		$V_{CC} = 4.5 V$	20	10	-	25	-	30	-	ns
		nMR HIGH; see <u>Figure 7</u>			1	1		1		1
		$V_{CC} = 4.5 V$	20	12	-	25	-	30	-	ns
t _{rec}	recovery time	nMR to nCP0, nCP1; see Figure 7								
		V _{CC} = 4.5 V	0	-8	-	0	-	0	-	ns
t _{su}	set-up time	nCP0 to nCP1; nCP1 to nCP0; see	Figu	e 7						
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
f _{max}	maximum	nCP0, nCP1; see Figure 7			1	1		1		1
	frequency	$V_{CC} = 4.5 V$	30	58	-	24	-	20	-	MHz
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	64	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	$V_{I} = \text{GND to } V_{CC} - 1.5 \text{ V}; \qquad [3]$ $V_{CC} = 5 \text{ V}; f_{i} = 1 \text{ MHz}$	-	24	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit, see Figure 8.

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

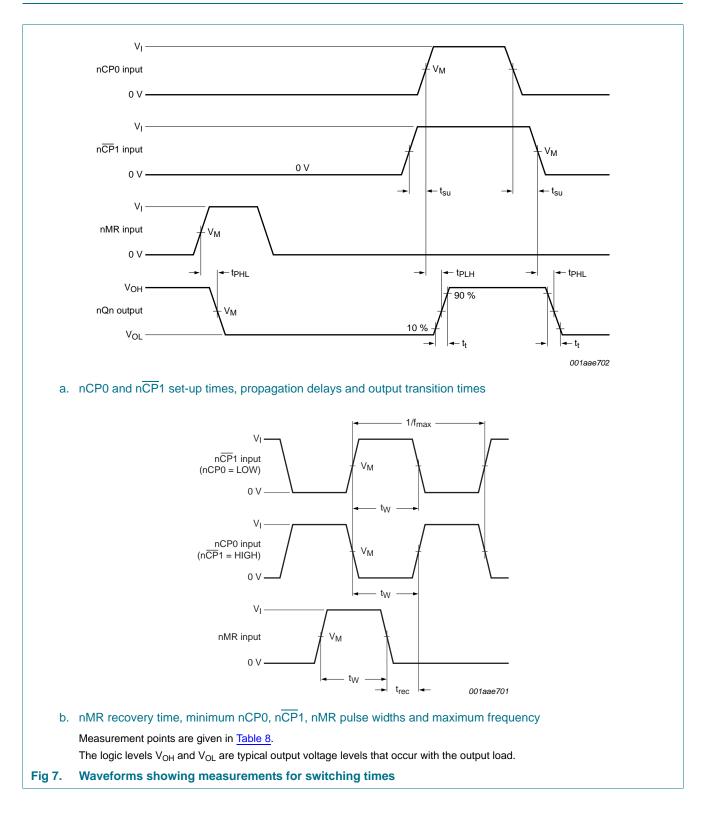
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

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74HC4520; 74HCT4520

Dual 4-bit synchronous binary counter

12. Waveforms



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Dual 4-bit synchronous binary counter

Table 8. Measurement	t points			
Туре	Input		Output	
	V _M	VI	V _M	
74HC4520	$0.5\times V_{CC}$	GND to V _{CC}	$0.5 imes V_{CC}$	
74HCT4520	1.3 V	GND to 3 V	1.3 V	

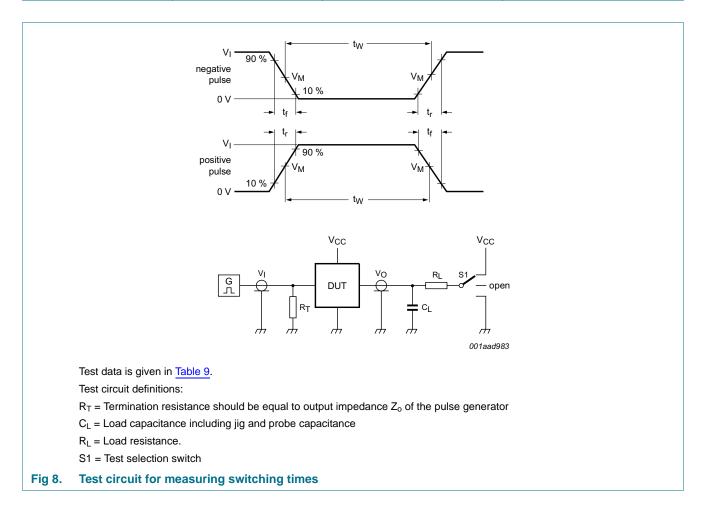
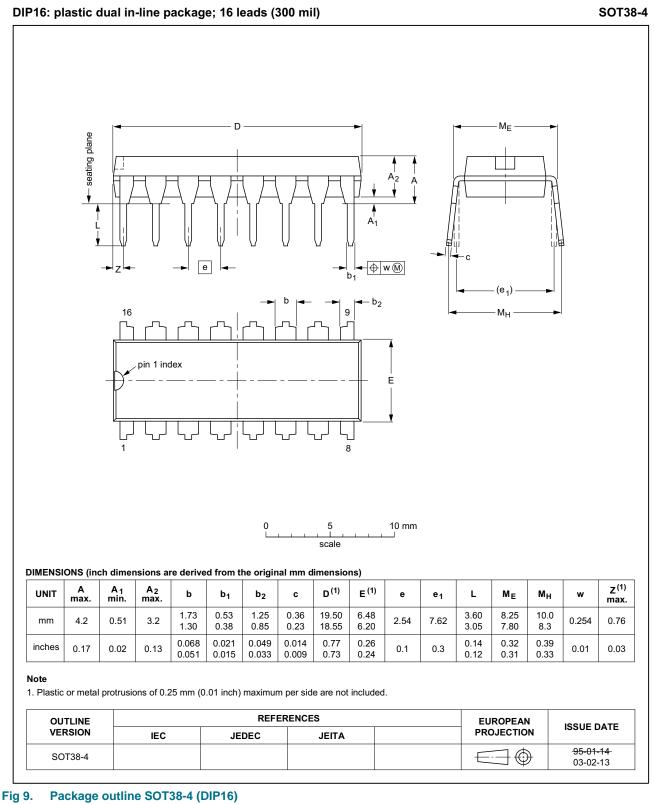


Table 9. Test data

Туре	Input		Load	S1 position	
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}
74HC4520	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT4520	3 V	6 ns	15 pF, 50 pF	1 kΩ	open



13. Package outline



74HC_HCT4520 **Product data sheet**

Dual 4-bit synchronous binary counter

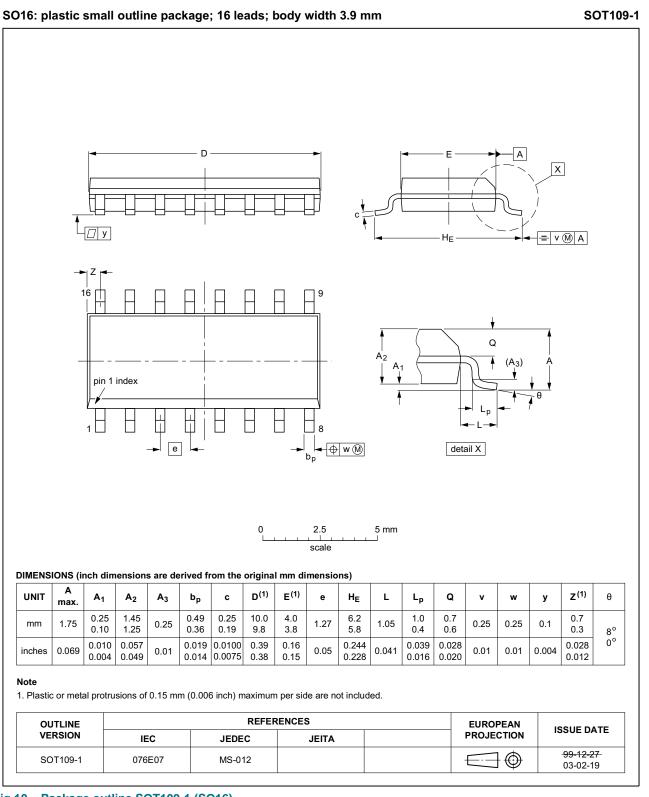


Fig 10. Package outline SOT109-1 (SO16)

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74HC_HCT4520

Product data sheet

Dual 4-bit synchronous binary counter

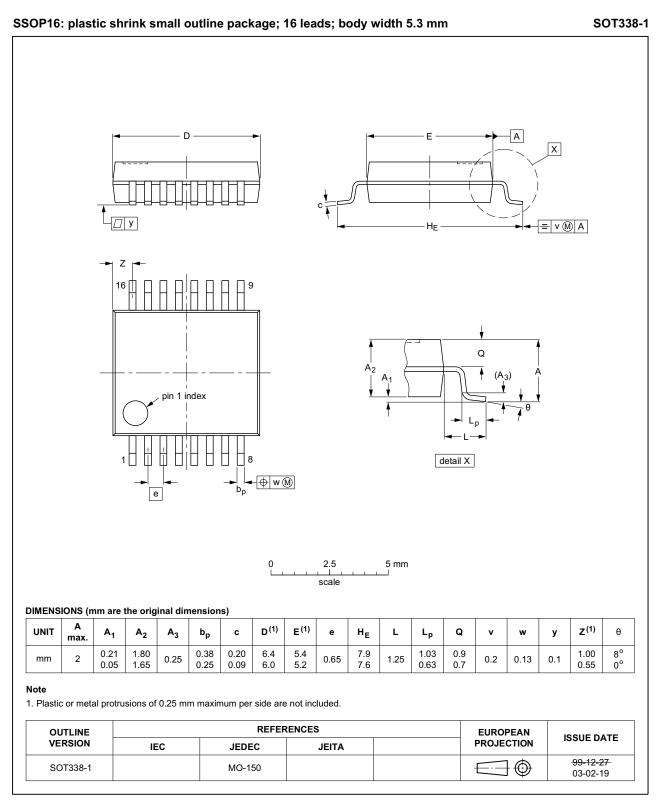


Fig 11. Package outline SOT338-1 (SSOP16)

74HC_HCT4520 Product data sheet

Dual 4-bit synchronous binary counter

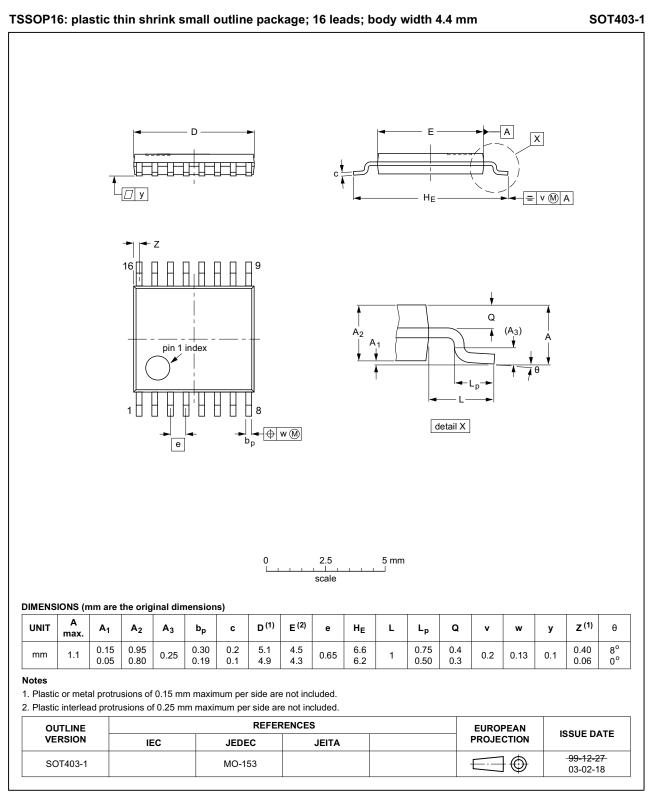


Fig 12. Package outline SOT403-1 (TSSOP16)

74HC_HCT4520 Product data sheet



14. Abbreviations

Table 10. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal-Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		
LSTTL	Low-power Schottky Transistor-Transistor Logic		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

15. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT4520 v.3	20141204	Product data sheet	-	74HC_HCT4520_CNV v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 				
74HC_HCT4520_CNV v.2	19930927	Product specification	-	-	

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

16.2 Definitions

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74HC_HCT4520

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18. Contents

1	General description 1
2	Features and benefits 1
3	Applications 1
4	Ordering information 2
5	Functional diagram 2
6	Pinning information 4
6.1	Pinning 4
6.2	Pin description 4
7	Functional description 5
8	Limiting values 5
9	Recommended operating conditions 6
10	Static characteristics 6
11	Dynamic characteristics 7
12	Waveforms 10
13	Package outline 12
14	Abbreviations 16
15	Revision history 16
16	Legal information 17
16.1	Data sheet status 17
16.2	Definitions 17
16.3	Disclaimers
16.4	Trademarks 18
17	Contact information 18
18	Contents 19

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